# Regarding the change of names mentioned in the document, such as Mitsubishi Electric and Mitsubishi XX, to Renesas Technology Corp.

The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

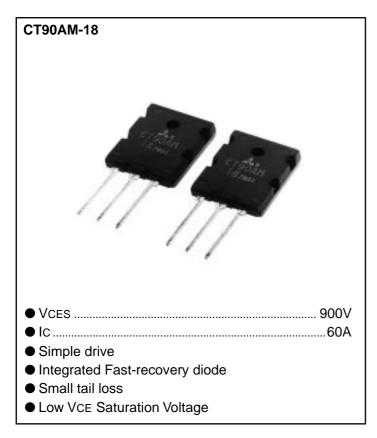
Note: Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

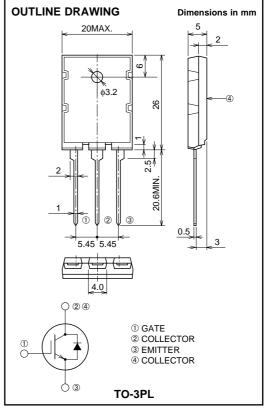
Renesas Technology Corp. Customer Support Dept. April 1, 2003



## CT90AM-18

#### **INSULATED GATE BIPOLAR TRANSISTOR**





#### **APPLICATION**

Microwave oven, Electoromagnetic cooking devices, Rice-cookers

#### MAXIMUM RATINGS (Tc = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
VCES	Collector-emitter voltage	VGE = 0V	900	V
VGES	Gate-emitter voltage		±25	V
VGEM	Peak gate-emitter voltage		±30	V
Ic	Collector current		60	Α
Ісм	Collector current (Pulsed)		120	Α
lE	Emitter current		40	Α
Pc	Maximum power dissipation		250	W
Tj	Junction temperature		<b>−</b> 40 ~ +150	Ŝ
Tstg	Storage temperature		-40 ~ +150	°C



### CT90AM-18

#### **INSULATED GATE BIPOLAR TRANSISTOR**

#### **ELECTRICAL CHARACTERISTICS** (Tj = 25°C)

Symbol	Parameter	Test conditions	Limits			1.1
			Min.	Тур.	Max.	Unit
ICES	Collector-emitter leakage current	VCE = 900V, VGE = 0V	_	_	1.0	mA
IGES	Gate-emitter leakage current	$VGE = \pm 20V$ , $VCE = 0V$	_	_	±0.5	μΑ
VGE (th)	Gate-emitter threshold voltage	VCE = 10V, IC = 6mA	2.0	4.0	6.0	V
VCE (sat)	Collector-emitter saturation voltage	IC = 60A, VGE = 15V	_	1.55	1.95	V
Cies	Input capacitance	VCE = 25V, VGE = 0V, f = 1MHz	_	11000	_	pF
Coes	Output capacitance		_	180	_	pF
Cres	Reverse transfer capacitance		_	125	_	pF
td (on)	Turn-on delay time	Vcc = 300V, Ic = 60A, VgE = 15V, Rg = 0Ω	_	0.05	_	μs
tr	Turn-on rise time		_	0.10	_	μs
td (off)	Turn-off delay time		_	0.20	_	μs
tf	Turn-off fall time		_	0.30	_	μs
Etail	Tail loss	ICP = 60A, Tj = 125°C, dv/dt = 200V/μs	_	0.6	1.0	mJ/pls
İtail	Tail current		_	6	12	Α
VEC	Emitter-collector voltage	IE = 60A, VGE = 0V	_	_	3.0	V
trr	Diode reverse recovery time	$IE = 60A$ , $dis/dt = -20A/\mu s$	_	0.5	2.0	μs
Rth (ch-c)	Thermal resistance	Junction to case	_	_	0.5	°C/W
Rth (ch-c)	Thermal resistance	Junction to case	_	_	4.0	°C/W

